



P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(ON)} max	I _D max T _A = 25°C
001/	$45 \text{m}\Omega$ @ $V_{GS} = -10 \text{V}$	-4.8A
-30V	80mΩ @ V _{GS} = -4.5V	-3.5A

Description

This MOSFET has been designed to minimize the on-state resistance $(R_{DS(on)})$ and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

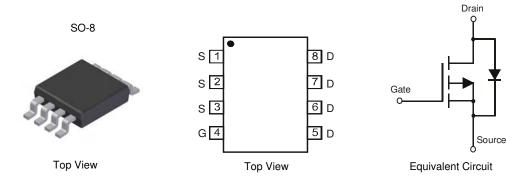
- Backlighting
- Power Management Functions
- DC-DC Converters

Features

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 standards for High Reliability

Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See diagram
- Terminals: Finish Matte Tin annealed over Copper leadframe.
 Solderable per MIL-STD-202, Method 208 ³
- Weight: 0.008 grams (approximate)



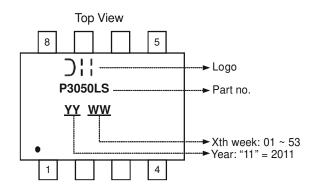
Ordering Information (Note 4)

Part Number	Case	Packaging
DMP3050LSS-13	SO-8	2500/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com.

Marking Information





Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic			Symbol	Value	Units
Drain-Source Voltage			V_{DSS}	-30	V
Gate-Source Voltage (Note 4)			V_{GSS}	±25	V
Continuous Drain Current (Note 5) V _{GS} = -10V	Steady State	$T_A = 25$ °C $T_A = 70$ °C	I _D	-4.8 -3.8	Α
	t<10s	$T_A = 25$ °C $T_A = 70$ °C	I _D	-6.3 -4.9	Α
Maximum Continuous Body Diode Forward Current (Note 6)			I _S	-3.0	Α
Pulsed Drain Current (10μs pulse, duty cycle = 1%)			I _{DM}	-30	Α

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units	
Total Bower Dissipation (Note 5)	$T_A = 25^{\circ}C$	D	1.7	W	
Total Power Dissipation (Note 5)	T _A = 70°C	P_{D}	1.1		
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	0	73	°C/W	
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	$R_{\theta JA}$	37		
Operating and Storage Temperature Range		$T_{J_i}T_{STG}$	-55 to 150	°C	

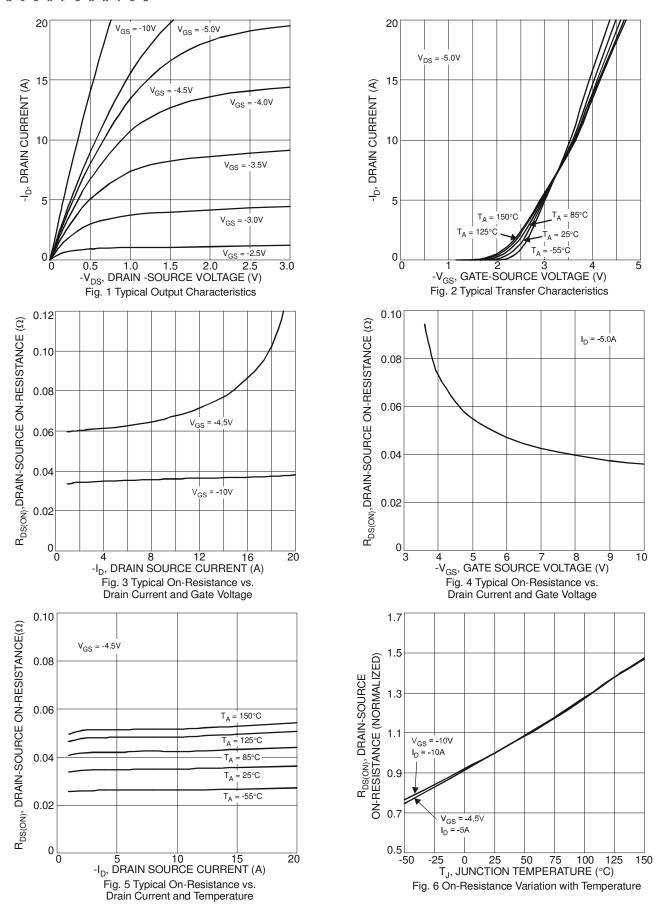
$\textbf{Electrical Characteristics} \ (@T_A = +25 ^{\circ}C, \ unless \ \ otherwise \ specified.)$

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 6)							
Drain-Source Breakdown Voltage	BV _{DSS}	-30	-	-	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	-	-	-1	μA	$V_{DS} = -30V, V_{GS} = 0V$	
Gate-Source Leakage	Igss	-	-	±100	nA	$V_{GS} = \pm 25V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 6)							
Gate Threshold Voltage	V _{GS(th)}	-1.0	-	-2.0	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
Static Drain-Source On-Resistance	D	-	36	45	mΩ	$V_{GS} = -10V, I_D = -6A$	
Static Drain-Source On-Nesistance	R _{DS (ON)}	-	61	80	m 7.2	$V_{GS} = -4.5V, I_D = -5A$	
Forward Transfer Admittance	Y _{fs}	-	4.8	-	S	$V_{DS} = -10V$, $I_{D} = -5.3A$	
Diode Forward Voltage	V _{SD}	-	-0.7	-1.0	V	$V_{GS} = 0V, I_S = -1.7A$	
DYNAMIC CHARACTERISTICS (Note 7)							
Input Capacitance	C _{iss}	-	620	-	рF	45)/ 1/ 0)/	
Output Capacitance	Coss	-	83	-	рF	V _{DS} = -15V, V _{GS} = 0V, -f = 1.0MHz	
Reverse Transfer Capacitance	C_{rss}	-	62	-	рF	T = T.OIVINZ	
Gate resistance	R_g	-	10.8	-	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (V _{GS} = -4.5V)	Qg	-	5.1	-	nC		
Total Gate Charge (V _{GS} = -10V)	Q_g	-	10.5	-	nC	\	
Gate-Source Charge	Q _{gs}	-	1.8	-	nC	$V_{DS} = -15V, I_D = -6A$	
Gate-Drain Charge	Q_{gd}	-	1.9	-	nC	1	
Turn-On Delay Time	t _{D(on)}	-	6.8	-	ns		
Turn-On Rise Time	tr	-	4.9	-	ns	$V_{DD} = -15V, V_{GS} = -10V,$ $R_G = 6\Omega, I_D = -1A$	
Turn-Off Delay Time	t _{D(off)}	-	28.4	-	ns		
Turn-Off Fall Time	t _f	-	12.4	-	ns		
Reverse Recovery Time	t _{rr}	-	14	-	ns	1 104 4:/44 5004/	
Reverse Recovery Charge	Q _{rr}	-	11	-	nC	$I_F = 12A$, di/dt = 500A/ μ s	

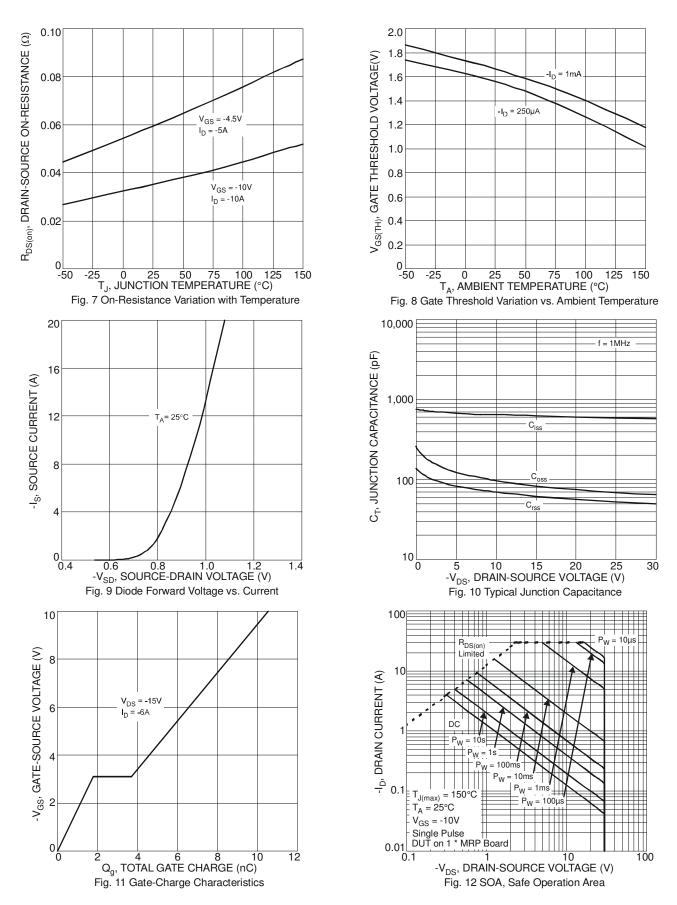
Notes: 4. AEC-Q101 V_{GS} maximum is ±20V

- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
- Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing.

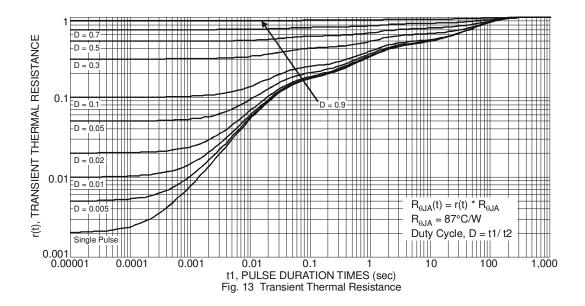






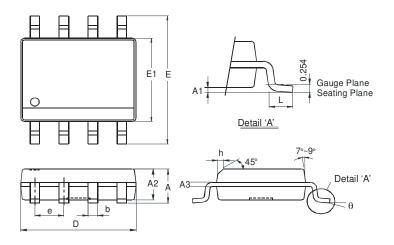






Package Outline Dimensions

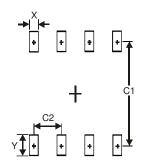
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SO-8				
Dim	Min	Max		
Α	-	1.75		
A 1	0.10	0.20		
A2	1.30	1.50		
А3	0.15	0.25		
b	0.3	0.5		
D	4.85	4.95		
Е	5.90	6.10		
E1	3.85	3.95		
е	1.27 Typ			
h	-	0.35		
L	0.62	0.82		
θ	0°	8°		
All Dimensions in mm				

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)			
Х	0.60			
Υ	1.55			
C1	5.4			
C2	1.27			



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